



## Trusted Foundry Program

As of February 16, 2024

### Accredited Suppliers

Important: Many of the following suppliers have a standard commercial (untrusted) product flow in addition to a trusted product flow. The "Trusted Product Flow" must be explicitly requested from the points of contact below to ensure the resulting product and/or service is trusted. A trusted supply chain begins with trusted design and continues with trusted mask, foundry, packaging/assembly, and test services.

Supplier	CAGE Code	Facility Location	Scope of Accreditation	POC	Email Address	Telephone Number
AccelerATE Solutions, Inc.	4ESJ8	San Jose, CA	Broker;Design	Thomas Nulsen	nulsente@acceler-ate.com	(408) 218-1978
Analog Devices Federal LLC	7EMW9	Chelmsford, MA	Broker;Design;Test	Susan Damiani	Susan.Damiani@analog.com	(978) 516-7712
Arkham Technology Ltd.	47RG0	Irvine, CA	Design	Otaway Thomas	othomas@arkhamtechnology.com	(949) 585-0404
BAE Systems Electronic Systems	1RU44	Manassas, VA	Broker;Design; Aggregation; Packaging/Assembly; Test	Brian Orlowsky	brian.orlowsky@baesystems.com	(571) 364-7789
BAE Systems Information & Electronic Systems Integration Inc.	8JPF5	Cedar Rapids, IA	Packaging/Assembly; Test	Brandon Hamilton	brandon.hamilton@baesystems.com	(812) 693-5126
BAE Systems Microelectronics Center Nashua	94117	Nashua, NH	Foundry Services	Douglas Dugas	douglas.m.dugas@baesystems.com	(603) 885-7016
Boeing Company	81205	Seattle, WA	Design	Wesley P. Hansford	wesley.p.hansford@boeing .com	(562) 344-7997
Cadence US, Inc	7PTP7	San Jose, CA	Design	Roy Robinson	robinson@cadence.com	(408) 382-2020
Chip Scan Inc	73SX3	Rockaway Beach, NY	Design	Dr. Simha S.	trustedic@chipscan.us	(332) 256-3381
Cobham Long Island	88379	Plainview, NY	Packaging/Assembly	Ronald Vogt	Ronald.Vogt@cobhamaes.com	(516) 752-2448
Collins Aerospace	13499	Cedar Rapids, IA	Design; Packaging/Assembly; Test	John Mulherin	john.mulherin@rockwellcollins.com	(319) 295-1703
Criteria Labs, Inc.	1NQ10	Austin, TX	Broker; Packaging/Assembly; Test	Doug Myron	dmyron@criterialabs.com	(512) 637-4549
Cubic Nuvotronics	5K5D0	Durham, NC	Post Processing; Packaging/Assembly	Alex Barani	abarani@nuvotronics.com	(540) 818-3724
Defense Microelectronics Activity	088N9	McClellan, CA	Broker;Design; FoundryServices; Packaging/Assembly; Test	Jeremy Bridge	jeremy.d.bridge.civ@mail.mil	(916) 231-1671
Department of Defense Microelectronics Solutions Group	98230	Fort Meade, MD	Design; Packaging/Assembly; Test	Keith L. Rogers, Ph.D.	klroger@radium.ncsc.mil	(240) 373-2990
DPA Components International	6S055	Simi Valley, CA	Packaging/Assembly; Test	Doug Schweitzer	dougs@dpaci.com	(805) 581-9200
Draper	51993	Cambridge, MA	Design;Post Processing;Packaging /Assembly;Test	Jane D, Forsyth	S&AS@draper.com	(617) 258-1389
Draper, St. Petersburg	5LQ37	St. Petersburg, FL 33716	Post Processing; Packaging/Assembly	Jane D. Forsyth	jforsyth@draper.com	(617-981-9855
FirstPass Engineering (Synopsys, Inc)	6WFA9	Phoenix, AZ	Design	Brad Bailey	bbailey@firstpasseng.com	(602) 680-9345
Frontgrade Colorado Springs LLC	65342	Colorado Springs, CO	Broker;Design; Aggregation; Packaging/Assembly; Test	Mark Beadle	Mark.Beadle@frontgrade.com	(719) 888-0114

General Dynamics Mission Systems, Scottsdale	1VPW8	Scottsdale, AZ	Broker;Design	Brian Nowak	Brian.Nowak@gd-ms.com	(480) 442-2200
GlobalFoundries Burlington	7DR37	Essex Junction, VT	Broker;Aggregation; Mask Data Parsing;Foundry Services;Post Processing;Test	Rich Mannherz	rich.mannherz@globalfoundries.com	(802) 734-1823
GlobalFoundries Malta	9D5Z9	Malta, NY	Broker; Foundry Services	Rich Mannherz	rich.mannherz@globalfoundries.com	(802) 393-9958
Grinding & Dicing Services Inc. a wholly owned business unit of Akoustis Technology	3FEJ2	San Jose, CA	Post Processing; Packaging/Assembly	General Manager	info@wafergrind.com	(408) 961-3720
Honeywell Aerospace Plymouth	34168	Plymouth, MN	Broker;Design; Foundry Services; Packaging/Assembly; Test	Thomas Romanko	Thomas.romanko@honeywell.com	(763) 954-2103
HRL Laboratories, LLC.	27457	Malibu, CA	Foundry Services	Kangmu Lee	klee@hrl.com	(310) 317-5914
Huntington Ingalls Industries	6V5Z8	Roanoke, VA	Design	Steve Baka	Stephen.Baka@hii-tsd.com	(540) 283-7542
IBM Corporation Bromont	L04D9	Bromont, Quebec, Canada	PostProcessing; Packaging/Assembly	Claude Letendre	cletendr@ca.ibm.com	(919) 830-5614
IBM Corporation Burlington	15898	Essex Junction, VT	Broker	Sam Hernandez	sam.hernandez@us.ibm.com	(720) 397-5590
IBM Corporation East Fishkill	1D185	Hopewell Junction, NY	Broker	Sam Hernandez	sam.hernandez@us.ibm.com	(720) 397-5590
IBM Corporation Malta	9BLW7	Malta NY	Broker	Eric J Rumbaugh	eric.rumbaugh@us.ibm.com	(802) 769-1900
Integra Technologies Silicon Valley	061F4	Milpitas, CA	Post Processing; Packaging/Assembly	Joe Foerstel	joe.foerstel@integra-tech.com	(408) 618-8752
Integra Technologies, LLC	1SRY1	Wichita, KS	Packaging/Assembly; Test	Kelly Priddy	kelly.pridy@integra-tech.com	(316) 630-6859
Interconnect Systems International, LLC	3F8U4	Camarillo CA	Packaging/Assembly	Thomas Casey Vice President	Thomas.Casey@molex.com	(805)384-4885
Jazz Semiconductor Trusted Foundry (JSTF)	6PN00	Irvine, CA	Broker	Scott Jordan	Jordans1@jazztrusted.com	(949) 861-3519
Johns Hopkins University, Applied Physics Laboratory	88898	Laurel, MD	Design	Shawn Seman	shawn.seman@jhuapl.edu	(240) 228-2843
Kansas City National Security Campus	14061	Kansas City, MO	Broker;Design; Aggregation; Post Processing; Packaging/Assembly; Test	Wayne Reed	wreed@kcncs.doe.gov	(816) 488-3965
L-3 Communications Systems - West	06401	Salt Lake City, UT	Design	Eric Hall	Eric.k.hall@L3Harris.com	(801) 594-2601
L3Harris Corporation Space & Airborne Systems	91417	Melbourne, FL	Design; Packaging/Assembly; Test	Louis Paradiso, Group Leader	lparadis@harris.com	(321) 727-1989
Lockheed Martin Missiles and Fire Control, Orlando	04939	Orlando, FL	Design	Zachary Davis	zachary.n.davis@lmco.com	(407) 356-1683
Lockheed Martin Space Systems Company, Denver	04236	Littleton, CO	Design	Joseph Hein, Sr. Manager	joseph.j.hein@lmco.com	(720) 503-4741
Lockheed Martin Space Systems Company, Sunnyvale	06887	Sunnyvale, CA	Design	Joseph Hein, Sr. Manager	joseph.j.hein@lmco.com	(720) 503-4741
Lockheed Martin Space Systems Company, Valley Forge	79272	King of Prussia, PA	Design	Joseph Hein, Sr. Manager	joseph.j.hein@lmco.com	(720) 503-4741
MACOM Technology Solutions Inc.	55NN2	Lowell, MA	Foundry Services; Post Processing	Jennifer Cort	jennifer.cort@macom.com	(978) 656-2345
Marvell Government Solutions, LLC	898N6	Essex Junction, VT	Broker;Design;Test	Richard Molino	mrich@marvellgs.com	(845) 892-0754
Maxtek Components Corp. dba Tektronix Component Solutions	06MJ2	Beaverton, OR	Packaging/Assembly; Test	Jillian Brazier	Components@tektronix.com	(503) 627-1486

Mercury System, Inc. - Phoenix Advanced Microelectronics Center	54230	Phoenix, AZ	Broker; Packaging/Assembly; Test	Charles Mertz	Charles.Mertz@mrscy.com	(602) 458-3461
Mercury Systems - Sensor and Mission Processing	3X893	Andover, MA	Design	Christina King	Christina.King@mrscy.com	(657) 465-0208
Microsemi a subsidiary of Microchip Corp	0J4Z0	San Jose, CA	Design;Test	Paul Doyle	Paul.Doyle@microchip.com	(408) 643-6200
Microsemi a subsidiary of Microchip Corp, Allentown	6WGS8	Allentown, PA	Broker;Design; Aggregation; Test	Paul Doyle	Paul.Doyle@microchip.com	(408) 643-6040
Micross Advance Interconnect Technology	7QZQ8	Durham, North Carolina	Post Processing; Packaging/Assembly	Alan Huffman/ John Lannon	Alan.Huffman@micross.com / John.Lannon@micross.com	(919) 248-9216 /(919) 248-1872
MIT Lincoln Laboratory Microelectronics Laboratory	3G050	Lexington, MA	Design;Aggregation; Foundry Services; Post Processing; Packaging/Assembly	Dan Pulver	MEL-Director@ll.mit.edu	(781) 981-1716
NEO Tech	09059	Chatsworth, CA	Packaging/Assembly	Steve Heinzen V.P. Marketing	steve.heinzen@neotech.com	(510) 933-6065
Northrop Grumman Mission Systems	15055	Linthicum, MD	Broker; Foundry Services; Packaging/Assembly; Test	Jeff Miller	j3.miller@ngc.com	(410) 765-3958
Northrop Grumman Space Systems	11982	Redondo Beach, CA	Design;Aggregation; Foundry Services; Post Processing; Packaging/Assembly; Test	Myra de Leon	myra.deleon@ngc.com	(310) 813-2719
ON Semiconductor - Gresham	5V1J0	Gresham, OR	Broker;Foundry Services; Post Processing	Troy Dye	troy.dye@onsemi.com	(208) 239-7013
ON Semiconductor - Pocatello	31471	Pocatello, ID	Broker;Design;Test	Troy Dye	troy.dye@onsemi.com	(208) 239-7013
Photronics Idaho, Inc.	860F3	Boise, ID	Mask Data Parsing; Mask Manufacturing	Eric Bawden	ebawden@photronics.com	(208) 908-4079
Photronics Texas Allen, Inc.	53Z12	Allen, TX	Mask Data Parsing; Mask Manufacturing	Darren Taylor	dtaylor@photronics.com	(512) 810-3400
Plexus Aerospace Defense and Security Services LLC	76QV7	Nampa, ID	Packaging/Assembly	Eric Holtz	Eric.holtz@plexus.com	(480) 532-2467
Qorvo Texas, LLC	1CVM1	Richardson, TX	Design; Foundry Services; Post Processing; Packaging/Assembly; Test	Ted Jones	TrustedIC@qorvo.com	(972) 994-4560
Raytheon Intelligence and Space, El Segundo	4U884	El Segundo, CA	Design;Test	David E. Lewis	delewis@raytheon.com	(310) 607-7878
Raytheon Intelligence and Space, McKinney	96214	McKinney, TX	Design	David E. Lewis	delewis@raytheon.com	(310) 607-7878
Raytheon Missile and Defense	15090	Tucson, AZ	Broker;Design; Packaging/Assembly	Bryon Hoinke	bryon_hoinke@raytheon.com	(520) 794-4226
Raytheon RF Components	05716	Andover, MA	Foundry Services	Ronald Gyurcsik, Ph.D. Director, Foundry Business Development	ronald.gyurcsik@raytheon.com	(978) 684-5428
Raytheon Vision Systems	11323	Goleta, CA	Design	Eric Beuville, PH.D.	Eric_Beuville@Raytheon.com	(805) 562-2021
Sandia National Laboratories Microsystems Engineering, Science & Applications (MESA)	14213	Albuquerque, NM	Design	Gina Chavez	ginchav@sandia.gov	(505) 284-4400
Sensors Unlimited, Inc.	0TGF6	Princeton, NJ	Aggregation; Post Processing; Packaging/Assembly; Test	Guy Bowie	guy.bowie@collins.com	(541) 308-1091
Silicon Turnkey Solutions, Inc.	1VPP6	Milpitas, CA	Packaging/Assembly; Test	Richard Scofield	Rscofield@sts-usa.com	(408) 904-0208
Six Sigma (dba) Winslow Automation	1PBC8	Milpitas, CA	Packaging/Assembly	Russ Winslow	russ@solderquik.com	(408) 956-0100 x111

SkyWater Technology Foundry, Inc.	5AZZ0	Bloomington, MN	Broker;Design; Foundry Services;Test	Brad Ferguson, CTO	brad.ferguson@skywatertechnology.com	(952) 851-5190
SRI International	ODKS7	Princeton, NJ	Foundry Services	David Weaver, PhD	David.weaver@sri.com	(609) 720-4845
Teledyne Advanced Electronics Solutions	26687	Lewisburg, TN	Packaging/Assembly; Test	John LeForge	John.LeForge@Teledyne.com	(931) 270-2735
Teledyne e2v HiRel Electronics	0C7V7	Milpitas, CA	Broker;Design; Packaging/Assembly; Test	Mont Taylor Dir. of Business Development	patricia.medina@teledyne.com	(408) 609-8787
The Boeing Company	9E831	El Segundo, CA	Design;Test	Eric Miller	Eric.J.Miller@boeing.com	(310) 416-5314
TLMI Corporation	3G0L2	Austin, TX	Post Processing	Michael Fredin	mfredin@tlmicorp.com	(512) 833-7075
Toppan Photomasks Round Rock, Inc.	8K0X2	Round Rock, TX	Mask Manufacturing	Kent Green	kent.green@us.photomask.com	(972) 839-3592
Trusted Semiconductor Solutions Inc.	4LZE5	Brooklyn Park, MN	Broker;Design; Aggregation	Stephanie Pusch	stephanie.pusch@trustedsemi.com	(612) 618-2115
USC, Information Sciences Institute, Arlington	06SU2	Arlington, VA	Design	Matthew French	mfrench@isi.edu	(703) 812-3733
USC-ISI - MOSIS	1B729	Marina del Rey, CA	Broker;Aggregation	Jaimie Kohls	jkohls@isi.edu	(310) 448-8214
Vortex Aerospace Design & Labs, Inc.	35TC6	Melbourne, FL	Broker;Design; Aggregation; Mask Data Parsing	Curtis Turner	trustedDesign@vortexaerospace.com	(813) 435-0528
Wolfspeed, Inc.	0C9J8	Durham, NC	Design;Foundry Services;Test	Anthony McCollum	Anthony.Mcollum@wolfspeed.com	(919) 407-4271

The Defense MicroElectronics Activity (DMEA) has been designated by the Department of Defense as the accrediting authority for this program.

Send questions or comments to [osd.mcclellan-park.dmea.list.trustedic@mail.mil](mailto:osd.mcclellan-park.dmea.list.trustedic@mail.mil)





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- Design
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- Broker
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- Mask Manufacturing
- Foundry
- Post-Processing
- Packaging/Assembly
- Test

